## Harvatek Surface Mount CHIP LEDs Data Sheet B1211UYG-20C001034U1930

Official Product	HT Part No. B1211UYG-20C001034U1930				
Tentative Product	******				
Specifications are subject notice. Proprietary data, d	10/25/2022	Version 1.1	Page 1/14		

DISCLAIMER
LIFE SUPPORT POLICY
PRODUCT SPECIFICATIONS4
ATTENTION: ELECTROSTATIC DISCHARGE (ESD) PROTECTION4
LABEL SPECIFICATIONS
SPECIFICATIONS RANGE
PRODUCT FEATURES
ELECTRO-OPTICAL CHARACTERISTICS7
PACKAGE OUTLINE DIMENSION AND RECOMMENDED SOLDERING PATTERN FOR REFLOW
Soldering
ABSOLUTE MAXIMUM RATINGS7
CHARACTERISTICS OF B1211UYG8
PRECAUTION FOR USE9
PRECAUTION FOR USE
PACKAGING10
PACKAGING
PACKAGING 10   TAPE DIMENSION 10   REEL DIMENSION 11   PACKING 11   DRY PACK 12   BAKING 12   PRECAUTIONS 12
PACKAGING
PACKAGING

7					
Official Product	HT Part No. B1211UYG-20C001034U1930				
Tentative Product	***************************************				
Specifications are subjec notice. Proprietary data, dr	10/25/2022	Version 1.1	Page 2/14		

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

7					
Official Product	HT Part No. B1211UYG-20C001034U1930				
Tentative Product	***************************************				
Specifications are subject notice. Proprietary data, dr	10/25/2022	Version 1.1	Page 3/14		

#### **Product Specifications**

Item	Specification	Material	Quantity
Luminous	UYG:45.0-180.0 mcd		
Intensity(Iv)	@20mA/ T <sub>s</sub> = 25 $^{\circ}$ C ;Tolerance: <u>+</u> 10%		
Wavelength	UYG:567.5-579.5 nm		
	@20mA/ Ts= 25°C;Tolerance: <u>+</u> 0.5nm		
Vf	UYG:1.6-2.4V		
	@20mA/ Ts= 25 $^\circ\!\mathrm{C}$ ;Tolerance: <u>+</u> 0.05V		
Ir	< 10µA @ V <sub>R</sub> = 5 V		
Resin	Clear	Ероху	
Carrier tape	EIA 481-1A specs	Conductive black tape	
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	250x230mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified
- · ·	1		1

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin

combinations of Iv,  $\lambda_D$  and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note : This is shipped test conditions

%Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

#### ATTENTION: Electrostatic Discharge (ESD) protection



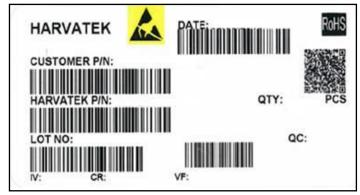
The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlGaInP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must

be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

	7					
	Official Product	HT Part No. B1211UYG-20C001034U1930				
	Tentative Product	*******				
ſ	Specifications are subject notice. Proprietary data, dr	10/25/2022	Version 1.1	Page 4/14		

### **Label Specifications**



#### Harvatek P/N:

## B 121 1 UYG- 20C- 0010 34

Product	Package	Dice Qty	Color	Current	Series Number	Taping
PCB	1.6(L)x1.0(W)x0.6(H) mm	1: Single	UYG: Ultra Bright Yellow Green	20mA	X001~XZZZ	1.Taping style 2. Qty

### Lot No.:

1 2	3	4	5	6	7	8	9	10
E 1	Α	1	Α	2	2	L	1	2
Code 1 2	Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Consecuti	ve number		Special code	2
Internal Tracing Code	2020-L 2021-M 2022-P 2023-Q  2026-T 2027-V  2030-Y 2031-Z 	1:Jan. 2:Feb.  A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C  26:Z 27:7 28:8 29:9 30:3 31:4	01-	-ZZ		000~ZZZ	

Official Product	HT Part No. B1211UYG-20C001034U1930				
Tentative Product	********				
Specifications are subjec notice. Proprietary data, dr	10/25/2022	Version 1.1	Page 5/14		

### **Specifications Range**

### Luminous Intensity (Iv) Bin:

Color	Bin Code	Spec. Range
	Р	45.00-71.50 mcd
UYG	Q	71.50-112.5 mcd
	R	112.5-180.0 mcd

Note: It maintains a tolerance of ±10% on Luminous Intensity

### Wavelength Bin:

Color	Bin Code	Spec. Range
	С	567.5-570.5 nm
	D	570.5-573.5 nm
UYG	E	573.5-576.5 nm
	F	576.5-579.5 nm

Note: It maintains a tolerance of ±0.5nm on Wavelength Bin

### Forward Voltage (Vf) Bin:

Color	Bin Code	Spec. Range
UYG	E18	1.6-2.4 V

Note: It maintains a tolerance of ±0.05V on forward voltage measurements

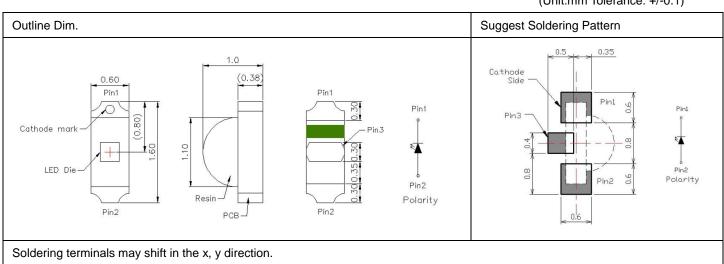
7					
Official Product	HT Part No. B1211UYG-20C001034U1930				
Tentative Product	********				
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#### **Product Features**

## **Electro-Optical Characteristics**

	•							( T <sub>Solde</sub>	<sub>ring</sub> , 25 °C)
Carios	Emitting Color	Material	V <sub>F</sub> (V)		Wavelength $\lambda(nm)$		l <sub>∨</sub> (mcd)	Viewing	
Series	Emitting Color	Material	typ	max	$\lambda_{D}$	$\lambda_{P}$	$ riangle \lambda$	Typical	Angle $2\theta \frac{1}{2}$
B1211UYG-20	LING	AlGaInP	2.1	2.4	571	573	15	71.5	X=135
B121101G-20	UYG	AIGaIIIP	2.1	2.4	571 575	, 15	71.5	Y=120	

## Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering



### Absolute Maximum Ratings

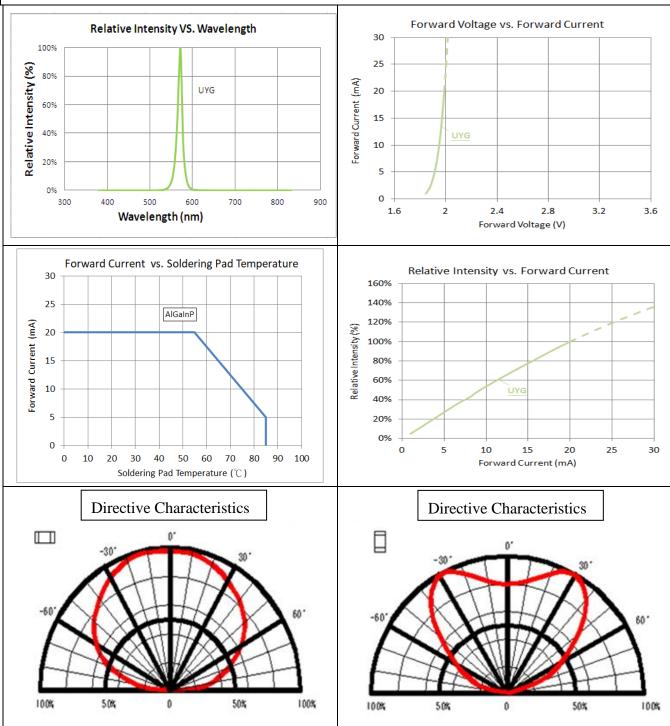
(T <sub>Soldering</sub> 25 °C)						
Series	P <sub>D</sub> (mW)	I <sub>F</sub> (mA)	I <sub>FP</sub> (mA)*	T <sub>OP</sub> ( <sup>°</sup> C)	T <sub>ST</sub> (°C)	
Color	Power Dissipation	Forward Current	Pulse Forward	Operating	Storage	
COIOI		r of ward Outfent	Current	Temperature	Temperature	
UYG	48	20	100	-40~+85	-40~+100	

\*Condition for  $I_{\text{FP}}$  is pulse of 1/10 duty and 0.1msec width

7					
Official Product	HT Part No. B1211UYG-20C001034U1930				
Tentative Product	**********				
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(Unit:mm Tolerance: +/-0.1)

#### Characteristics of B1211UYG



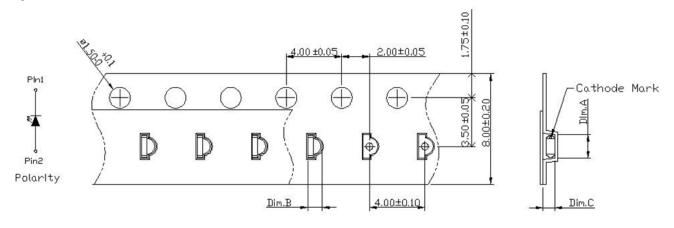
Official Product	HT Part No. B1211UYG-20C001034U1930				
Tentative Product	*********				
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		10/25/2022	Version 1.1	Page 8/14	

#### Precaution for Use

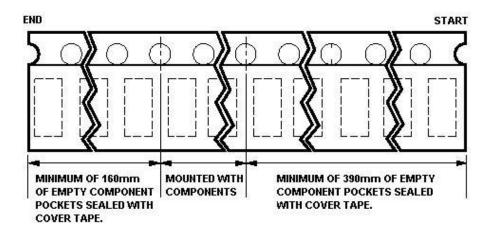
- 1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
- 2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
- 3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
- 4. The LEDs must be used within 4 weeks after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
- 5. The appearance and specifications of the products may be modified for improvement without further notice.
- 6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs.If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs.Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

7					
Official Product	HT Part No. B1211UYG-20C001034U1930				
Tentative Product	**********				
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		10/25/2022	Version 1.1	Page 9/14	

## Packaging Tape Dimension

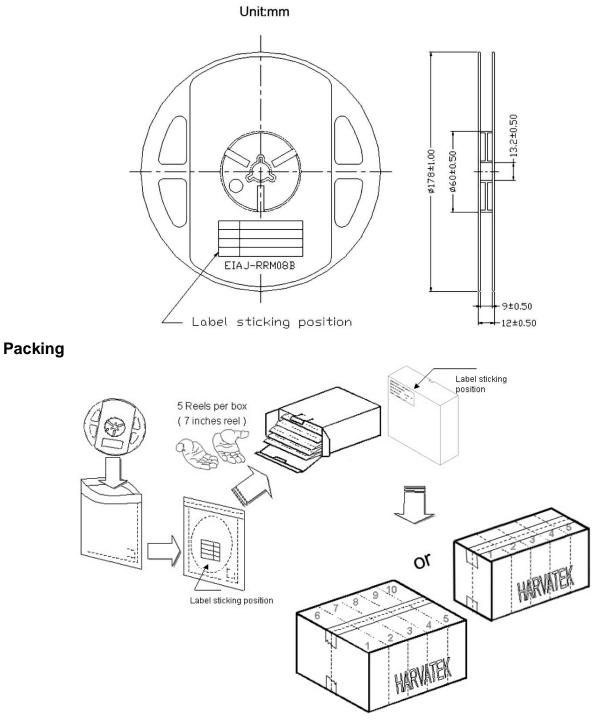


Dim. A	Dim. B	Dim. C	Qty/Reel
1.72 +0.1-0.05	1.05 +0.1-0.05	0.85±0.10	4K



Official Product	HT Part No. B1211UYG-20C001034U1930				
Tentative Product	*********				
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		10/25/2022	Version 1.1	Page 10/14	

### **Reel Dimension**



5 or 10 boxes per carton is available depending on shipment quantity.

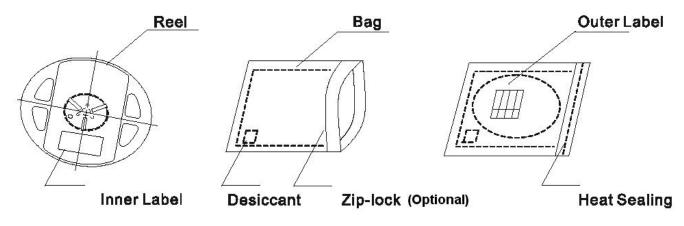
7					
Official Product	HT Part No. B1211UYG-20C001034U1930				
Tentative Product	***************************************				
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		10/25/2022	Version 1.1	Page 11/14	

### **Dry Pack**

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

A humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



## Baking

Baking before soldering is recommended when the package has been unsealed for 4 weeks. The conditions are as followings:

- 1.  $60\pm3^{\circ}C\times(12\sim24hrs)$  and <5% RH, taped reel type.
- 2. 100±3°C ×(45min~1hr), bulk type.
- 3. 130±3°C ×(15min~30min), bulk type.

### Precautions

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlGaInP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

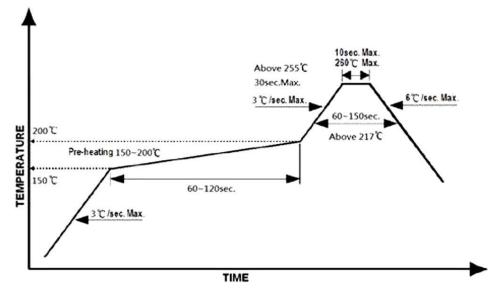
7					
Official Product	HT Part No. B1211UYG-20C001034U1930				
Tentative Product	*****				
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		10/25/2022	Version 1.1	Page 12/14	

### **Reflow Soldering**

Recommend soldering paste specifications:

- 1. Operating temp.: Above 217 <sup>o</sup>C ,60-150 sec.
- 2. Peak temp.:260 <sup>O</sup>CMax.,10sec Max.
- 3. Reflow soldering should not be done more than two times.
- 4. Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



### Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

### Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 <sup>O</sup>C max, <3min

7					
Official Product	HT Part No. B1211UYG-20C001034U1930				
Tentative Product	*****	****			
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		10/25/2022	Version 1.1	Page 13/14	

### **Cautions of Pick and Place**

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

#### **Revise History**

Rev.	Descriptions	Date	Page
1.0	-	06/05/2018	-
1.1	Renew Form	10/25/2022	-

Official Product	HT Part No. B1211UYG-20C001034U1930			
Tentative Product	*****	****		
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		10/25/2022	Version 1.1	Page 14/14